Double Balanced Mixer 3 - 10 GHz



CGY2182UH/C1

Rev. V1

Features

RF and LO Range: 3 - 10 GHz

IF Range: DC - 3 GHz
Conversion Loss: 60 dB
LO to RF Isolation: 45 dB
LO to IF Isolation: 32 dB
Input P1dB: 12 dBm

• Small Chip Size: 1.5 x 1.5 x 0.1 mm

Tested, Inspected Known Good Die (KGD)

Evaluation Boards Available

Space and MIL-STD also Available

RoHS* Compliant

Applications

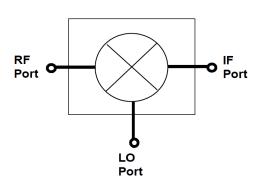
- GPS Systems
- Radar
- Telecommunication
- Instrumentation

Description

The CGY2182UH/C1 is a high performance GaAs pHEMT technology based double balanced mixer MMIC with on chip RF and LO baluns. This device covers the frequency range of 3 GHz to 10 GHz with a conversion loss of typically 7 dB. On-chip baluns provide excellent rejection of LO to RF and IF paths. High dynamic range is provided by the passive mixer configuration.

The die is manufactured using 0.18 µm gate length pHEMT Technology. The MMIC uses gold bond pads and backside metallization and is fully protected with Silicon Nitride passivation to obtain the highest level of reliability. This technology has been evaluated for Space applications and is on the European Preferred Parts List of the European Space Agency.

Block Diagram



Ordering Information

Part Number	Package
CGY2182UH/C1	Double balanced quad mixer
CGY2182GS/C1	Hermetically sealed double balanced quad mixer

^{*} Restrictions on Hazardous Substances, compliant to current RoHS EU directive.



Electrical Specifications: Down Converter Mode, Measured on Wafer, LO Power = +15 dBm

Parameter	Test Conditions	Units	Min.	Тур.	Max.
LO and RF Frequency	_	GHz	3	_	10
IF Frequency	_	GHz	DC	_	3
Conversion Loss	_	dB	_	7	10
SSB Noise Figure	_	dB	_	7	_
Isolation	LO to RF (Up Converter Mode) LO to IF	dB	_	60 45	_
P1dB	_	dBm	_	12	_

Absolute Maximum Ratings^{1,2}

Parameter	Absolute Maximum
Input Power	
LO	17.5 dBm
RF	15.0 dBm
IF	15.0 dBm
Junction Temperature	+150°C
Operating Temperature	-40°C to +85°C
Storage Temperature	-55°C to +150°C

^{1.} Exceeding any one or combination of these limits may cause permanent damage to this device.

Handling Procedures

Please observe the following precautions to avoid damage:

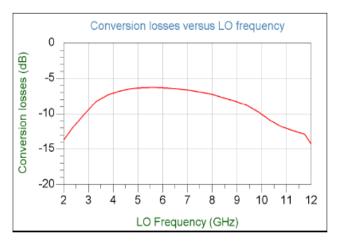
Static Sensitivity

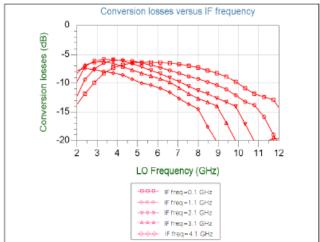
These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

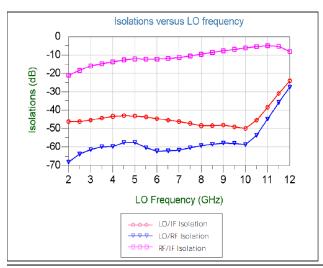
MACOM does not recommend sustained operation near these survivability limits.

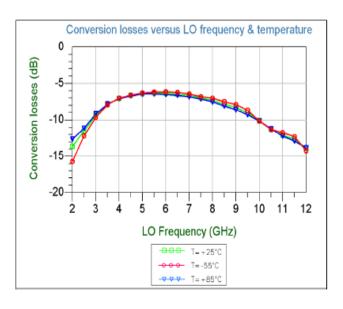


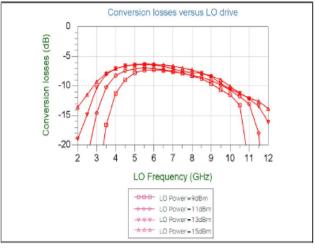
Typical Performance Curves: Down Conversion Mode LO Power: +15 dBm, RF Power: -15 dBm, IF Frequency: 0.1 GHz











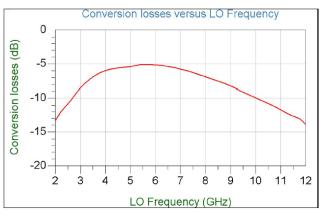
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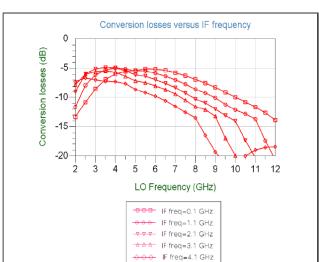
Visit www.macom.com for additional data sheets and product information.

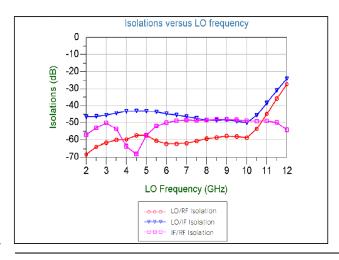
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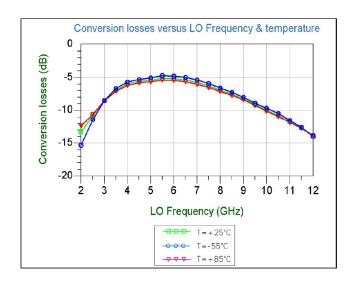


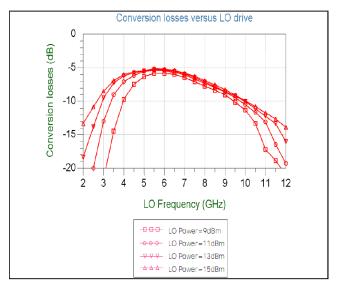
Typical Performance Curves: Up Conversion Mode LO Power: +15 dBm, IF Power: -15 dBm, IF Frequency: 0.1 GHz











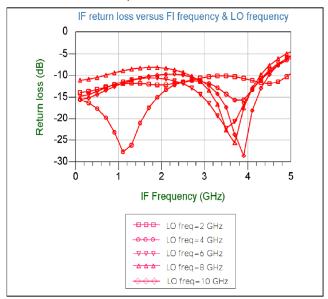
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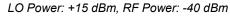
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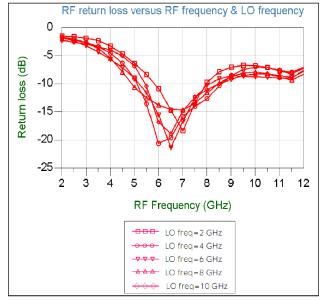


Typical Performance Curves: Up or Down Conversion Mode

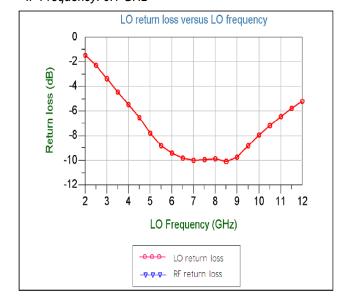
LO Power: +15 dBm, IF Power: -40 dBm







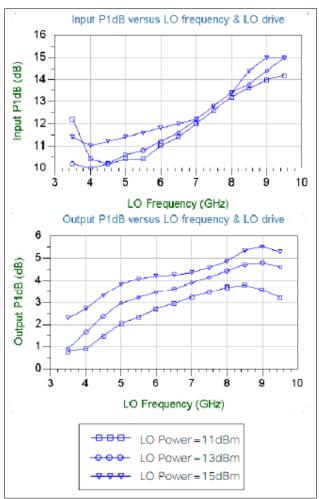
LO Power: +15 dBm, RF Power: -15 dBm IF Frequency: 0.1 GHz



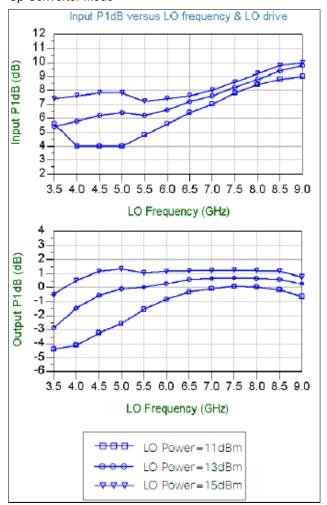


Typical Performance Curves: IF Frequency: 0.1 GHz

Down Converter Mode



Up Converter Mode



Double Balanced Mixer 3 - 10 GHz



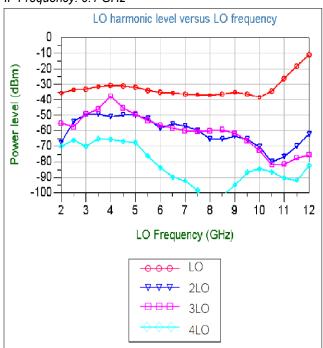
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Typical Performance Curves:

Down Converter Mode

LO Power: +13 dBm, RF Power: -10 dBm

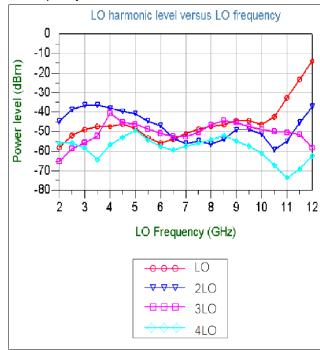
IF Frequency: 0.1 GHz



Up Converter Mode

LO Power: +13 dBm, IF Power: -10 dBm

IF Frequency: 0.1 GHz

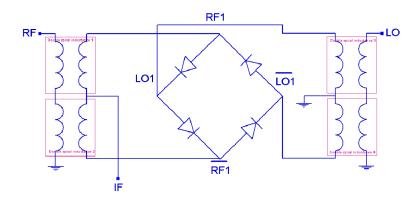




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Block Diagram



Pad Position

Pad Name	Coordinate X (μm) Y (μm)		Description
Pau Name			Description
LO	460	1353	Local Oscillator Input
RF	460	112	RF Input
IF	1353	689	IF Output

X=0, Y=0 at bottom left corner.

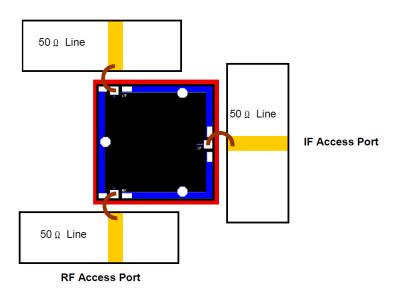
Co-ordinates correspond to the center of the bonding pad.

See Mechanical Information for more details.

Bonding Diagram & Assembly Information

The bonding wires should be gold and be as short as possible. The CGY2182UH/C1 uses through substrate via holes to obtain excellent RF grounding. The backside of the MMIC must be appropriately connected to the system ground.

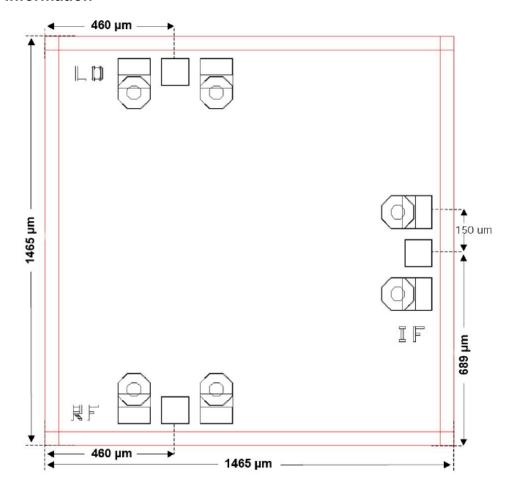
LO Access Port



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Mechanical Information



Chip Size: 1465 μm x 1465 μm (after wafer sawing) Substrate Thickness: 100 μm

Back-Side Metallization: yes Use of Via-Holes: yes RF Pads Size: 100 x 100 µm

Double Balanced Mixer 3 - 10 GHz



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